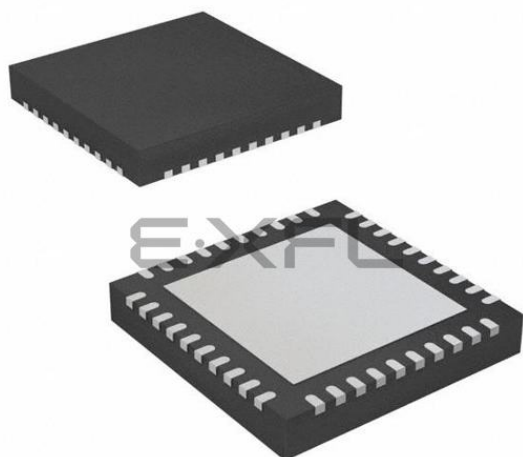




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Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	LINbus, UART/USART
Peripherals	Brown-out Detect/Reset, LCD, POR, PWM, WDT
Number of I/O	36
Program Memory Size	7KB (4K x 14)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 14x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	40-UQFN Exposed Pad
Supplier Device Package	40-UQFN (5x5)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lf1904-e-mv

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PIC16LF1904/6/7

1.0 DEVICE OVERVIEW

The PIC16LF1904/6/7 are described within this data sheet. They are available in 28, 40 and 44-pin packages. Figure 1-1 shows a block diagram of the PIC16LF1904/6/7 devices. Table 1-2 shows the pinout descriptions.

Reference Table 1-1 for peripherals available per device.

TABLE 1-1: DEVICE PERIPHERAL SUMMARY

Peripheral		PIC16LF1906	PIC16LF1904/7
ADC		•	•
EUSART		•	•
Fixed Voltage Reference (FVR)		•	•
LCD		•	•
Temperature Indicator		•	•
Timers			
	Timer0	•	•
	Timer1	•	•

TABLE 3-3: PIC16LF1904/6/7 MEMORY MAP

BANK 0		BANK 1		BANK 2		BANK 3		BANK 4		BANK 5		BANK 6		BANK 7	
000h	Core Registers (Table 3-2)	080h	Core Registers (Table 3-2)	100h	Core Registers (Table 3-2)	180h	Core Registers (Table 3-2)	200h	Core Registers (Table 3-2)	280h	Core Registers (Table 3-2)	300h	Core Registers (Table 3-2)	380h	Core Registers (Table 3-2)
00Bh		08Bh		10Bh		18Bh		20Bh		28Bh		30Bh		38Bh	
00Ch	PORTA	08Ch	TRISA	10Ch	LATA	18Ch	ANSELA	20Ch	—	28Ch	—	30Ch	—	38Ch	—
00Dh	PORTB	08Dh	TRISB	10Dh	LATB	18Dh	ANSELB	20Dh	WPUB	28Dh	—	30Dh	—	38Dh	—
00Eh	PORTC	08Eh	TRISC	10Eh	LATC	18Eh	—	20Eh	—	28Eh	—	30Eh	—	38Eh	—
00Fh	PORTD ⁽¹⁾	08Fh	TRISD ⁽¹⁾	10Fh	LATD ⁽¹⁾	18Fh	—	20Fh	—	28Fh	—	30Fh	—	38Fh	—
010h	PORTE	090h	TRISE ⁽¹⁾	110h	LATE ⁽¹⁾	190h	ANSELE ⁽¹⁾	210h	WPUE	290h	—	310h	—	390h	—
011h	PIR1	091h	PIE1	111h	—	191h	PMADRL	211h	—	291h	—	311h	—	391h	—
012h	PIR2	092h	PIE2	112h	—	192h	PMADRH	212h	—	292h	—	312h	—	392h	—
013h	—	093h	—	113h	—	193h	PMDATL	213h	—	293h	—	313h	—	393h	—
014h	—	094h	—	114h	—	194h	PMDATH	214h	—	294h	—	314h	—	394h	IOCBP
015h	TMR0	095h	OPTION_REG	115h	—	195h	PMCON1	215h	—	295h	—	315h	—	395h	IOCBN
016h	TMR1L	096h	PCON	116h	BORCON	196h	PMCON2	216h	—	296h	—	316h	—	396h	IOCBF
017h	TMR1H	097h	WDTCON	117h	FVRCON	197h	—	217h	—	297h	—	317h	—	397h	—
018h	T1CON	098h	—	118h	—	198h	—	218h	—	298h	—	318h	—	398h	—
019h	T1GCON	099h	OSCCON	119h	—	199h	RCREG	219h	—	299h	—	319h	—	399h	—
01Ah	—	09Ah	OSCSTAT	11Ah	—	19Ah	TXREG	21Ah	—	29Ah	—	31Ah	—	39Ah	—
01Bh	—	09Bh	ADRESL	11Bh	—	19Bh	SPBRG	21Bh	—	29Bh	—	31Bh	—	39Bh	—
01Ch	—	09Ch	ADRESH	11Ch	—	19Ch	SPBRGH	21Ch	—	29Ch	—	31Ch	—	39Ch	—
01Dh	—	09Dh	ADCON0	11Dh	—	19Dh	RCSTA	21Dh	—	29Dh	—	31Dh	—	39Dh	—
01Eh	—	09Eh	ADCON1	11Eh	—	19Eh	TXSTA	21Eh	—	29Eh	—	31Eh	—	39Eh	—
01Fh	—	09Fh	—	11Fh	—	19Fh	BAUDCON	21Fh	—	29Fh	—	31Fh	—	39Fh	—
020h	General Purpose Register 96 Bytes	0A0h	General Purpose Register 80 Bytes	120h	General Purpose Register 80 Bytes	1A0h	General Purpose Register 80 Bytes ⁽²⁾	220h	General Purpose Register 80 Bytes ⁽²⁾	2A0h	General Purpose Register 80 Bytes ⁽²⁾	320h	General Purpose Register 32 Bytes ⁽²⁾	3A0h	Unimplemented Read as ‘0’
06Fh		0EFh		13Fh		1EFh		26Fh		2EFh		Unimplemented Read as ‘0’			
070h		0F0h	Accesses 70h – 7Fh	170h	Accesses 70h – 7Fh	1F0h	Accesses 70h – 7Fh	270h	Accesses 70h – 7Fh	2F0h	Accesses 70h – 7Fh	370h	Accesses 70h – 7Fh	3F0h	Accesses 70h – 7Fh
07Fh		0FFh		17Fh		1FFh		27Fh		2FFh		37Fh	3FFh		

Legend: = Unimplemented data memory locations, read as '0'.

Note 1: PIC16LF1904/7 only.

Note 2: PIC16LF1906/7 only.

4.2 Code Protection

Code protection allows the device to be protected from unauthorized access. Program memory protection is controlled independently. Internal access to the program memory is unaffected by any code protection setting.

4.2.1 PROGRAM MEMORY PROTECTION

The entire program memory space is protected from external reads and writes by the CP bit in Configuration Word 1. When $\overline{CP} = 0$, external reads and writes of program memory are inhibited and a read will return all '0's. The CPU can continue to read program memory, regardless of the protection bit settings. Writing the program memory is dependent upon the write protection setting. See **Section 4.3 "Write Protection"** for more information.

4.3 Write Protection

Write protection allows the device to be protected from unintended self-writes. Applications, such as boot loader software, can be protected while allowing other regions of the program memory to be modified.

The WRT<1:0> bits in Configuration Word 2 define the size of the program memory block that is protected.

4.4 User ID

Four memory locations (8000h-8003h) are designated as ID locations where the user can store checksum or other code identification numbers. These locations are readable and writable during normal execution. See **Section 10.4 "User ID, Device ID and Configuration Word Access"** for more information on accessing these memory locations. For more information on checksum calculation, see the *"PIC16F193X/LF193X/PIC16F194X/LF194X/PIC16LF190X Memory Programming Specification"* (DS41397).

REGISTER 6-2: OSCSTAT: OSCILLATOR STATUS REGISTER

R-1/q	U-0	R-q/q	R-0/q	U-0	U-0	R-0/0	R-0/q
T1OSCR	—	OSTS	HFIOFR	—	—	LFIOFR	HFIOFS
bit 7							bit 0

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	q = Conditional

bit 7	T1OSCR: Timer1 Oscillator Ready bit If T1OSCCN = 1: 1 = Timer1 oscillator is ready 0 = Timer1 oscillator is not ready If T1OSCCN = 0: 1 = Timer1 clock source is always ready
bit 6	Unimplemented: Read as '0'
bit 5	OSTS: Oscillator Start-up Time-out Status bit 1 = Running from the external clock source (EC) 0 = Running from an internal oscillator (FOSC<1:0> = 00)
bit 4	HFIOFR: High-Frequency Internal Oscillator Ready bit 1 = HFINTOSC is ready 0 = HFINTOSC is not ready
bit 3-2	Unimplemented: Read as '0'
bit 1	LFIOFR: Low-Frequency Internal Oscillator Ready bit 1 = LFINTOSC is ready 0 = LFINTOSC is not ready
bit 0	HFIOFS: High-Frequency Internal Oscillator Stable bit 1 = HFINTOSC 16 MHz oscillator is stable and is driving the INTOSC 0 = HFINTOSC 16 MHz oscillator is not stable, the start-up oscillator is driving INTOSC

TABLE 6-2: SUMMARY OF REGISTERS ASSOCIATED WITH CLOCK SOURCES

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
OSCCON	—	IRCF<3:0>				—	SCS<1:0>		58
OSCSTAT	T1OSCR	—	OSTS	HFIOFR	—	—	LFIOFR	HFIOFS	59
T1CON	TMR1CS<1:0>		T1CKPS<1:0>		T1OSCCN	T1SYNC	—	TMR1ON	139

Legend: — = unimplemented location, read as '0'. Shaded cells are not used by clock sources.

TABLE 6-3: SUMMARY OF CONFIGURATION WORD WITH CLOCK SOURCES

Name	Bits	Bit -/7	Bit -/6	Bit 13/5	Bit 12/4	Bit 11/3	Bit 10/2	Bit 9/1	Bit 8/0	Register on Page
CONFIG1	13:8	—	—	—	—	CLKOUTEN	BOREN<1:0>		—	39
	7:0	CP	MCLRE	PWRT $\overline{\text{E}}$	WDTE<1:0>		—	FOSC<1:0>		

Legend: — = unimplemented location, read as '0'. Shaded cells are not used by clock sources.

7.6.3 PIE2 REGISTER

The PIE2 register contains the interrupt enable bits, as shown in Register 7-3.

Note: Bit PEIE of the INTCON register must be set to enable any peripheral interrupt.

REGISTER 7-3: PIE2: PERIPHERAL INTERRUPT ENABLE REGISTER 2

U-0	U-0	U-0	U-0	U-0	R/W-0/0	U-0	U-0
—	—	—	—	—	LCDIE	—	—
bit 7						bit 0	

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

u = Bit is unchanged

x = Bit is unknown

-n/n = Value at POR and BOR/Value at all other Resets

'1' = Bit is set

'0' = Bit is cleared

bit 7-3 **Unimplemented:** Read as '0'

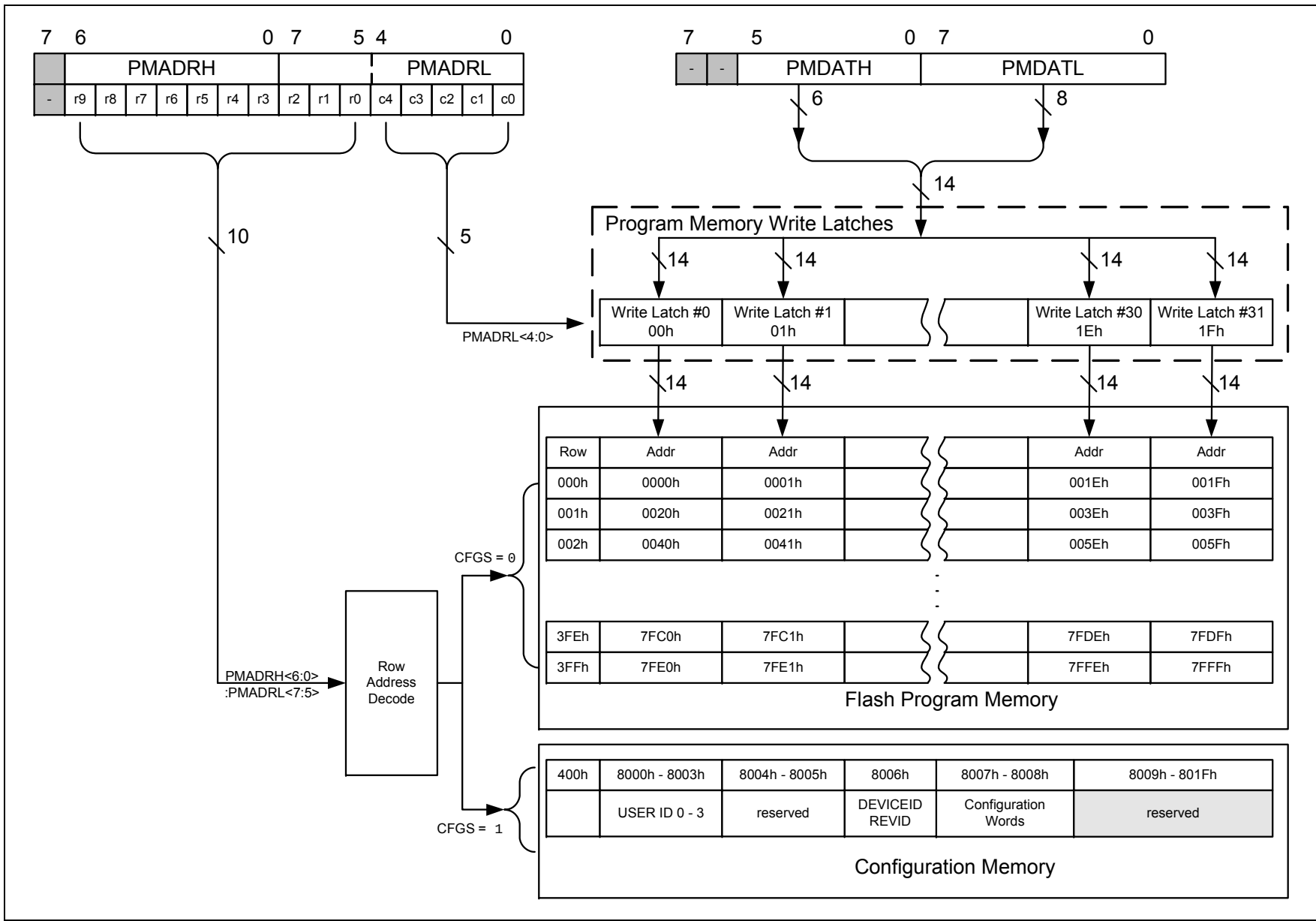
bit 2 **LCDIE:** LCD Module Interrupt Enable bit

1 = Enables the LCD module interrupt

0 = Disables the LCD module interrupt

bit 1-0 **Unimplemented:** Read as '0'

FIGURE 10-5: BLOCK WRITES TO FLASH PROGRAM MEMORY WITH 32 WRITE LATCHES



PIC16LF1904/6/7

EXAMPLE 10-3: WRITING TO FLASH PROGRAM MEMORY

```
; This write routine assumes the following:
; 1. 64 bytes of data are loaded, starting at the address in DATA_ADDR
; 2. Each word of data to be written is made up of two adjacent bytes in DATA_ADDR,
;    stored in little endian format
; 3. A valid starting address (the least significant bits = 00000) is loaded in ADDRH:ADDRL
; 4. ADDRH and ADDRL are located in shared data memory 0x70 - 0x7F (common RAM)
;
    BCF      INTCON,GIE      ; Disable ints so required sequences will execute properly
    BANKSEL  PMADRH          ; Bank 3
    MOVF     ADDRH,W         ; Load initial address
    MOVWF    PMADRH          ;
    MOVF     ADDRL,W         ;
    MOVWF    PMADRL         ;
    MOVLW    LOW DATA_ADDR  ; Load initial data address
    MOVWF    FSR0L           ;
    MOVLW    HIGH DATA_ADDR ; Load initial data address
    MOVWF    FSR0H           ;
    BCF      PMCON1,CFG5     ; Not configuration space
    BSF      PMCON1,WREN     ; Enable writes
    BSF      PMCON1,LWLO     ; Only Load Write Latches

LOOP
    MOVIW    FSR0++          ; Load first data byte into lower
    MOVWF    PMDATL          ;
    MOVIW    FSR0++          ; Load second data byte into upper
    MOVWF    PMDATH          ;

    MOVF     PMADRL,W        ; Check if lower bits of address are '00000'
    XORLW    0x1F            ; Check if we're on the last of 32 addresses
    ANDLW    0x1F            ;
    BTFSC    STATUS,Z        ; Exit if last of 32 words,
    GOTO     START_WRITE     ;

    Required Sequence
    MOVLW    55h             ; Start of required write sequence:
    MOVWF    PMCON2          ; Write 55h
    MOVLW    0AAh            ;
    MOVWF    PMCON2          ; Write AAh
    BSF      PMCON1,WR        ; Set WR bit to begin write
    NOP      ; NOP instructions are forced as processor
    NOP      ; loads program memory write latches
    NOP      ;

    INCF     PMADRL,F         ; Still loading latches Increment address
    GOTO     LOOP            ; Write next latches

START_WRITE
    BCF      PMCON1,LWLO     ; No more loading latches - Actually start Flash program
                                ; memory write

    Required Sequence
    MOVLW    55h             ; Start of required write sequence:
    MOVWF    PMCON2          ; Write 55h
    MOVLW    0AAh            ;
    MOVWF    PMCON2          ; Write AAh
    BSF      PMCON1,WR        ; Set WR bit to begin write
    NOP      ; NOP instructions are forced as processor writes
    NOP      ; all the program memory write latches simultaneously
    NOP      ; to program memory.
    NOP      ; After NOPs, the processor
    NOP      ; stalls until the self-write process is complete
    NOP      ; after write processor continues with 3rd instruction

    BCF      PMCON1,WREN     ; Disable writes
    BSF      INTCON,GIE      ; Enable interrupts
```

PIC16LF1904/6/7

REGISTER 10-6: PMCON2: PROGRAM MEMORY CONTROL 2 REGISTER

W-0/0	W-0/0	W-0/0	W-0/0	W-0/0	W-0/0	W-0/0	W-0/0
Program Memory Control Register 2							
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
S = Bit can only be set x = Bit is unknown -n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set '0' = Bit is cleared

Flash Memory Unlock Pattern bits

To unlock writes, a 55h must be written first, followed by an AAh, before setting the WR bit of the PMCON1 register. The value written to this register is used to unlock the writes. There are specific timing requirements on these writes.

TABLE 10-3: SUMMARY OF REGISTERS ASSOCIATED WITH FLASH PROGRAM MEMORY

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
PMCON1	— ⁽¹⁾	CFGS	LWLO	FREE	WRERR	WREN	WR	RD	91
PMCON2	Program Memory Control Register 2								92
PMADRL	PMADRL<7:0>								90
PMADRH	— ⁽¹⁾	PMADRH<6:0>							90
PMDATL	PMDATL<7:0>								90
PMDATH	—	—	PMDATH<5:0>						90
INTCON	GIE	PEIE	TMR0IE	INTE	IOCIE	TMR0IF	INTF	IOCIF	65

Legend: — = unimplemented location, read as '0'. Shaded cells are not used by the Flash Program Memory module.

Note 1: Unimplemented, read as '1'.

TABLE 10-4: SUMMARY OF CONFIGURATION WORD WITH FLASH PROGRAM MEMORY

Name	Bits	Bit -/7	Bit -/6	Bit 13/5	Bit 12/4	Bit 11/3	Bit 10/2	Bit 9/1	Bit 8/0	Register on Page
CONFIG1	13:8	—	—	—	—	CLKOUTEN	BOREN<1:0>		—	39
	7:0	CP	MCLRE	PWRTE	WDTE<1:0>		—	FOSC<1:0>		
CONFIG2	13:8	—	—	LVP	DEBUG	LPBOR	BORV	STVREN	—	40
	7:0	—	—	—	—	—	—	WRT<1:0>		

Legend: — = unimplemented location, read as '0'. Shaded cells are not used by the Flash Program Memory.

11.3 PORTC Registers

PORTC is an 8-bit wide bidirectional port. The corresponding data direction register is TRISC (Register 11-6). Setting a TRISC bit (= 1) will make the corresponding PORTC pin an input (i.e., put the corresponding output driver in a High-Impedance mode). Clearing a TRISC bit (= 0) will make the corresponding PORTC pin an output (i.e., enable the output driver and put the contents of the output latch on the selected pin). Example 11-1 shows how to initialize an I/O port.

Reading the PORTC register (Register 11-5) reads the status of the pins, whereas writing to it will write to the PORT latch. All write operations are read-modify-write operations. Therefore, a write to a port implies that the port pins are read, this value is modified and then written to the PORT data latch (LATC).

The TRISC register (Register 11-6) controls the PORTC pin output drivers, even when they are being used as analog inputs. The user should ensure the bits in the TRISC register are maintained set when using them as analog inputs. I/O pins configured as analog input always read '0'.

11.3.1 PORTC FUNCTIONS AND OUTPUT PRIORITIES

Each PORTC pin is multiplexed with other functions. The pins, their combined functions and their output priorities are shown in Table 11-7.

When multiple outputs are enabled, the actual pin control goes to the peripheral with the highest priority.

Analog input and some digital input functions are not included in the list below. These input functions can remain active when the pin is configured as an output. Certain digital input functions override other port functions and are included in Table 11-7.

TABLE 11-7: PORTC OUTPUT PRIORITY

Pin Name	Function Priority ⁽¹⁾
RC0	T1OSO T1CKI RC0
RC1	T1OSI RC1
RC2	SEG2 RC2
RC3	SEG6 RC3
RC4	SEG11 T1G RC4
RC5	SEG10 RC5
RC6	SEG9 RC6 TX/CK
RC7	SEG8 RC7 RX/DT

Note 1: Priority listed from highest to lowest.

REGISTER 11-10: PORTC: PORTC REGISTER

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
RC7	RC6	RC5	RC4	RC3	RC2	RC1	RC0
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

u = Bit is unchanged

x = Bit is unknown

-n/n = Value at POR and BOR/Value at all other Resets

'1' = Bit is set

'0' = Bit is cleared

bit 7-0 **RC<7:0>**: PORTC General Purpose I/O Pin bits⁽¹⁾
 1 = Port pin is $\geq V_{IH}$
 0 = Port pin is $\leq V_{IL}$

Note 1: Writes to PORTC are actually written to the corresponding LATC register. Reads from the PORTC register is return of actual I/O pin values.

REGISTER 11-11: TRISC: PORTC TRI-STATE REGISTER

R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1
TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

u = Bit is unchanged

x = Bit is unknown

-n/n = Value at POR and BOR/Value at all other Resets

'1' = Bit is set

'0' = Bit is cleared

bit 7-0 **TRISC<7:0>**: PORTC Tri-State Control bits
 1 = PORTC pin configured as an input (tri-stated)
 0 = PORTC pin configured as an output

REGISTER 11-12: LATC: PORTC DATA LATCH REGISTER

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
LATC7	LATC6	LATC5	LATC4	LATC3	LATC2	LATC1	LATC0
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

u = Bit is unchanged

x = Bit is unknown

-n/n = Value at POR and BOR/Value at all other Resets

'1' = Bit is set

'0' = Bit is cleared

bit 7-0 **LATC<7:0>**: PORTC Output Latch Value bits⁽¹⁾

Note 1: Writes to PORTC are actually written to corresponding LATC register. Reads from PORTC register is return of actual I/O pin values.

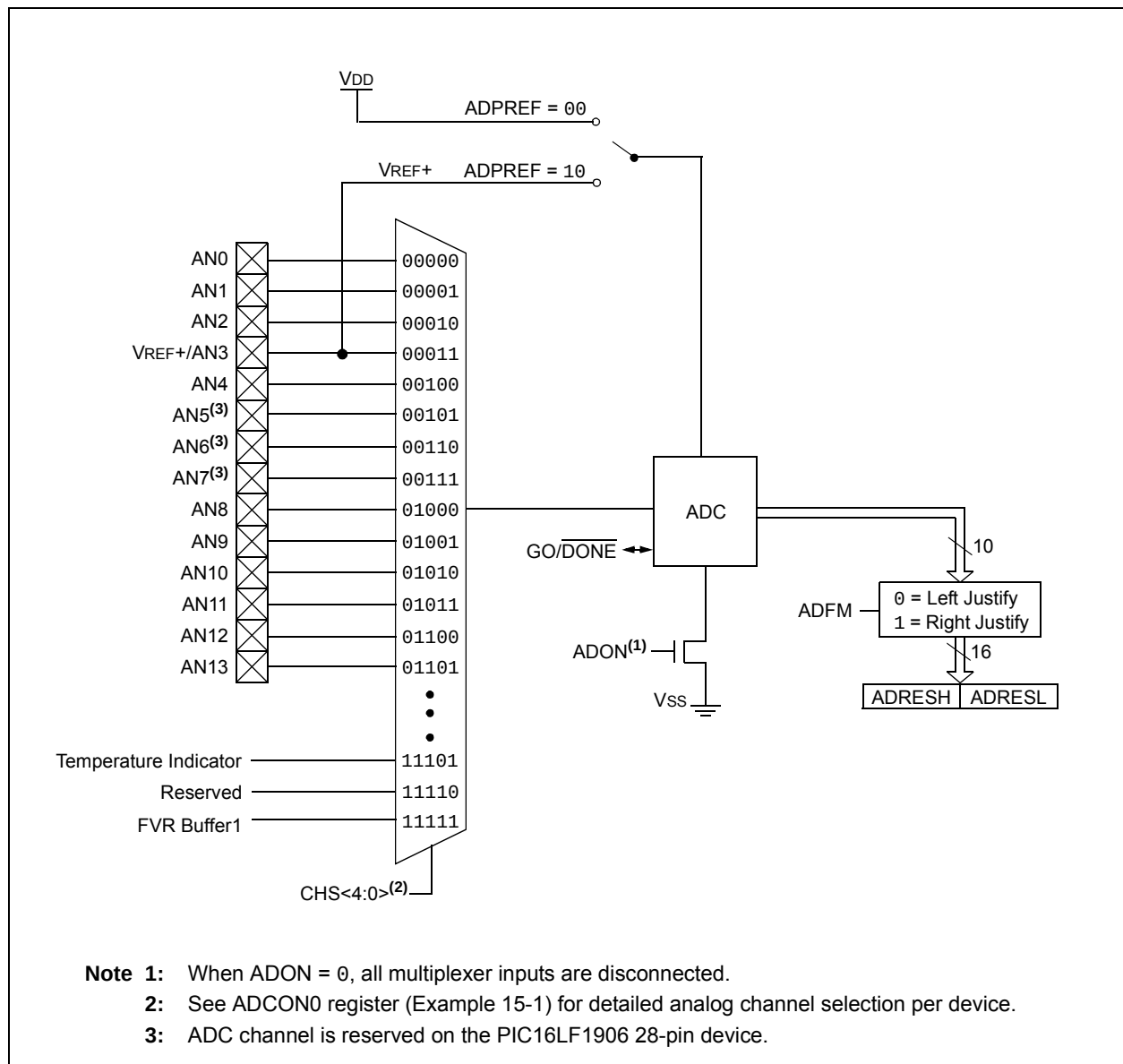
15.0 ANALOG-TO-DIGITAL CONVERTER (ADC) MODULE

The Analog-to-Digital Converter (ADC) allows conversion of an analog input signal to a 10-bit binary representation of that signal. This device uses analog inputs, which are multiplexed into a single sample and hold circuit. The output of the sample and hold is connected to the input of the converter. The converter generates a 10-bit binary result via successive approximation and stores the conversion result into the ADC result registers (ADRESH:ADRESL register pair). Figure 15-1 shows the block diagram of the ADC.

The ADC voltage reference is software selectable to be either internally generated or externally supplied.

The ADC can generate an interrupt upon completion of a conversion. This interrupt can be used to wake-up the device from Sleep.

FIGURE 15-1: ADC BLOCK DIAGRAM



15.2 ADC Operation

15.2.1 STARTING A CONVERSION

To enable the ADC module, the ADON bit of the ADCON0 register must be set to a '1'. Setting the GO/DONE bit of the ADCON0 register to a '1' will start the Analog-to-Digital conversion.

Note: The GO/DONE bit should not be set in the same instruction that turns on the ADC. Refer to **Section 15.2.5 "A/D Conversion Procedure"**.

15.2.2 COMPLETION OF A CONVERSION

When the conversion is complete, the ADC module will:

- Clear the GO/DONE bit
- Set the ADIF Interrupt Flag bit
- Update the ADRESH and ADRESL registers with new conversion result

15.2.3 TERMINATING A CONVERSION

If a conversion must be terminated before completion, the GO/DONE bit can be cleared in software. The ADRESH and ADRESL registers will be updated with the partially complete Analog-to-Digital conversion sample. Incomplete bits will match the last bit converted.

Note: A device Reset forces all registers to their Reset state. Thus, the ADC module is turned off and any pending conversion is terminated.

15.2.4 ADC OPERATION DURING SLEEP

The ADC module can operate during Sleep. This requires the ADC clock source to be set to the FRC option. When the FRC clock source is selected, the ADC waits one additional instruction before starting the conversion. This allows the SLEEP instruction to be executed, which can reduce system noise during the conversion. If the ADC interrupt is enabled, the device will wake-up from Sleep when the conversion completes. If the ADC interrupt is disabled, the ADC module is turned off after the conversion completes, although the ADON bit remains set.

When the ADC clock source is something other than FRC, a SLEEP instruction causes the present conversion to be aborted and the ADC module is turned off, although the ADON bit remains set.

FIGURE 17-5: TIMER1 GATE SINGLE-PULSE MODE

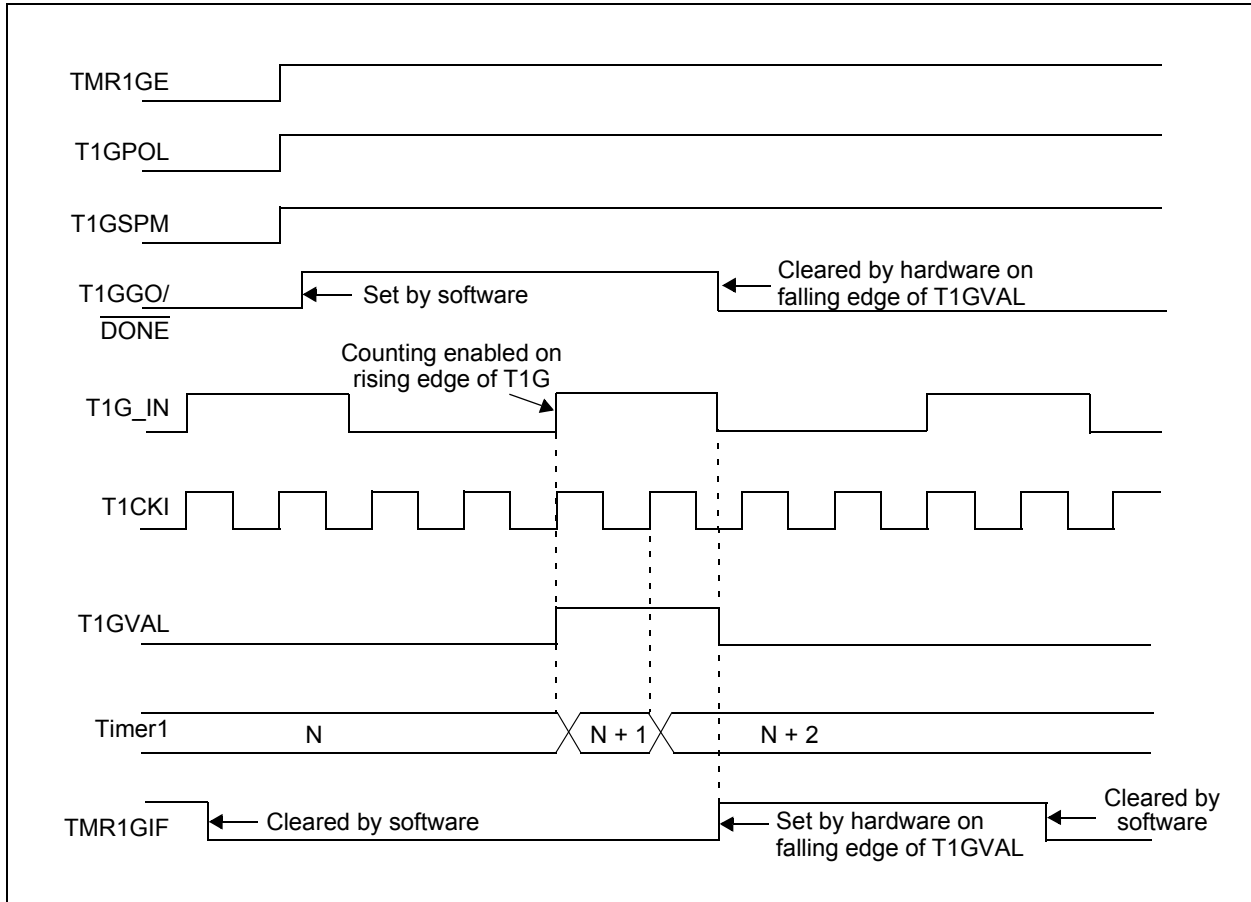


FIGURE 18-10: SYNCHRONOUS TRANSMISSION

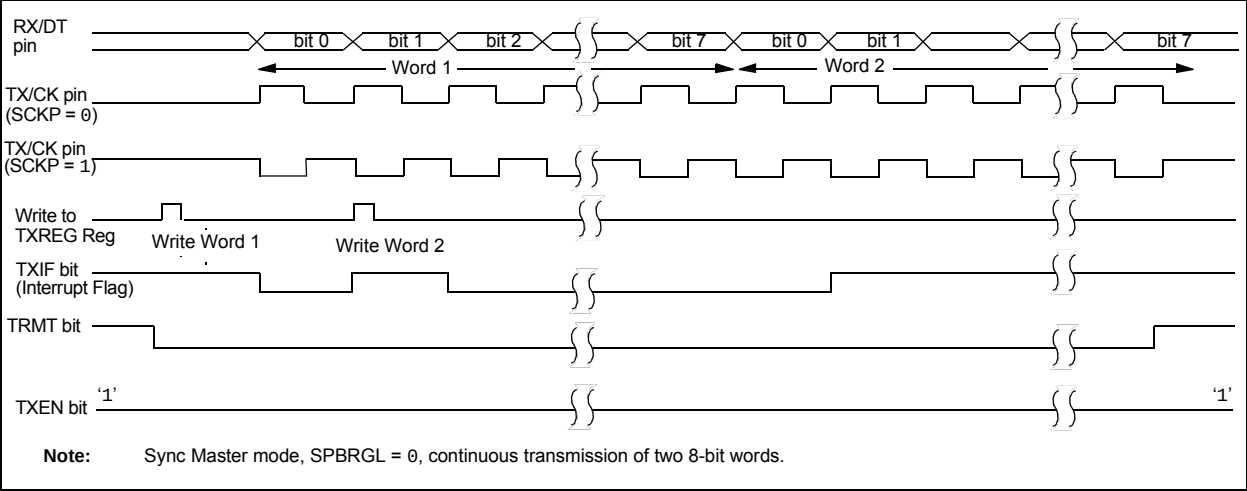
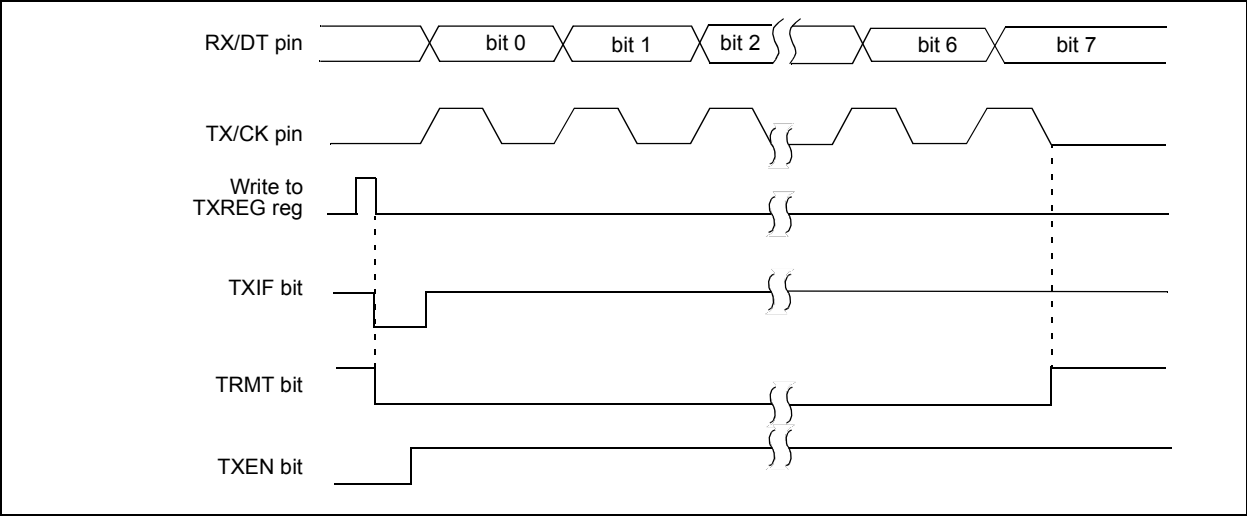


FIGURE 18-11: SYNCHRONOUS TRANSMISSION (THROUGH TXEN)



19.4.3 AUTOMATIC POWER MODE SWITCHING

As an LCD segment is electrically only a capacitor, current is drawn only during the interval where the voltage is switching. To minimize total device current, the LCD internal reference ladder can be operated in a different power mode for the transition portion of the duration. This is controlled by the LCDRL Register (Register 19-7).

The LCDRL register allows switching between two power modes, designated 'A' and 'B'. 'A' Power mode is active for a programmable time, beginning at the time when the LCD segments transition. 'B' Power mode is the remaining time before the segments or commons change again. The LRLAT<2:0> bits select how long, if any, that the 'A' Power mode is active. Refer to Figure 19-4.

To implement this, the 5-bit prescaler used to divide the 32 kHz clock down to the LCD controller's 1 kHz base rate is used to select the power mode.

FIGURE 19-4: LCD INTERNAL REFERENCE LADDER POWER MODE SWITCHING DIAGRAM – TYPE A

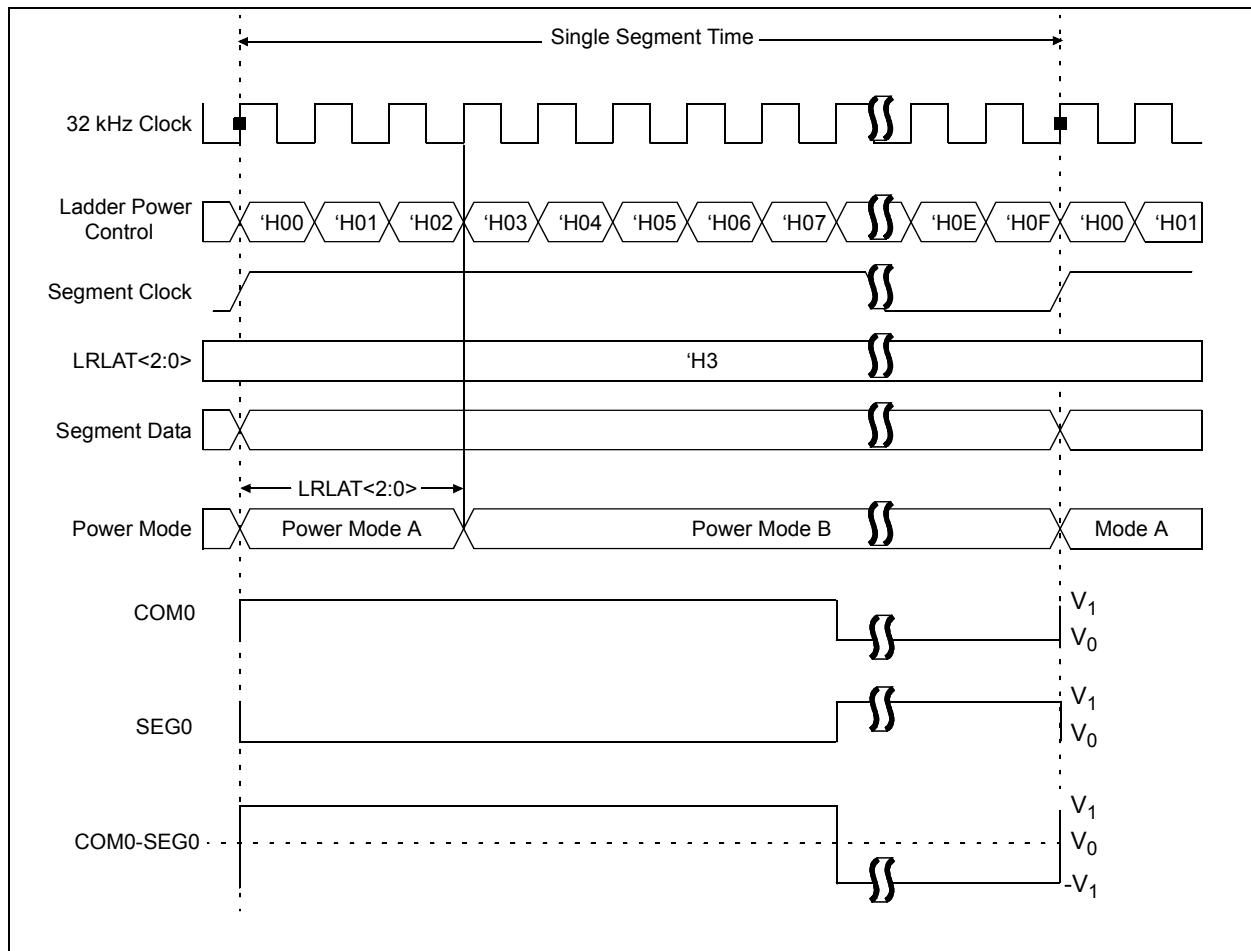
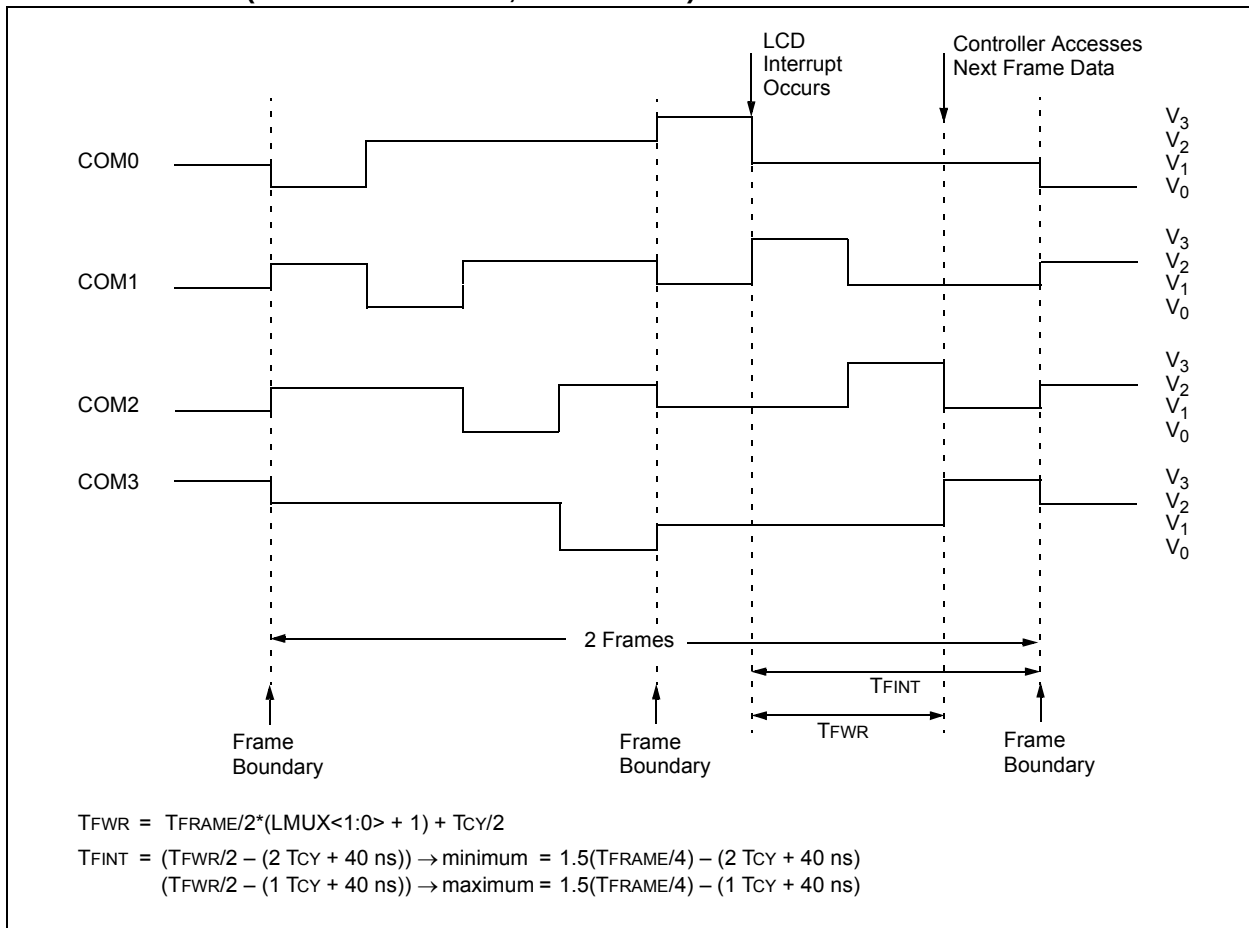


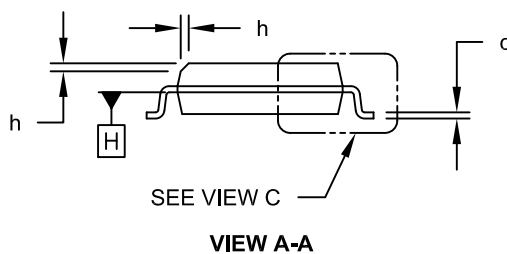
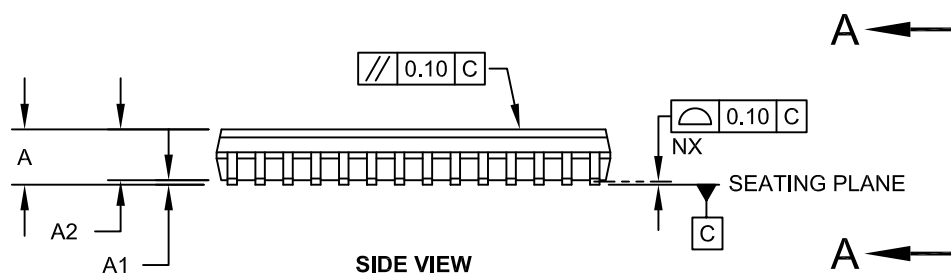
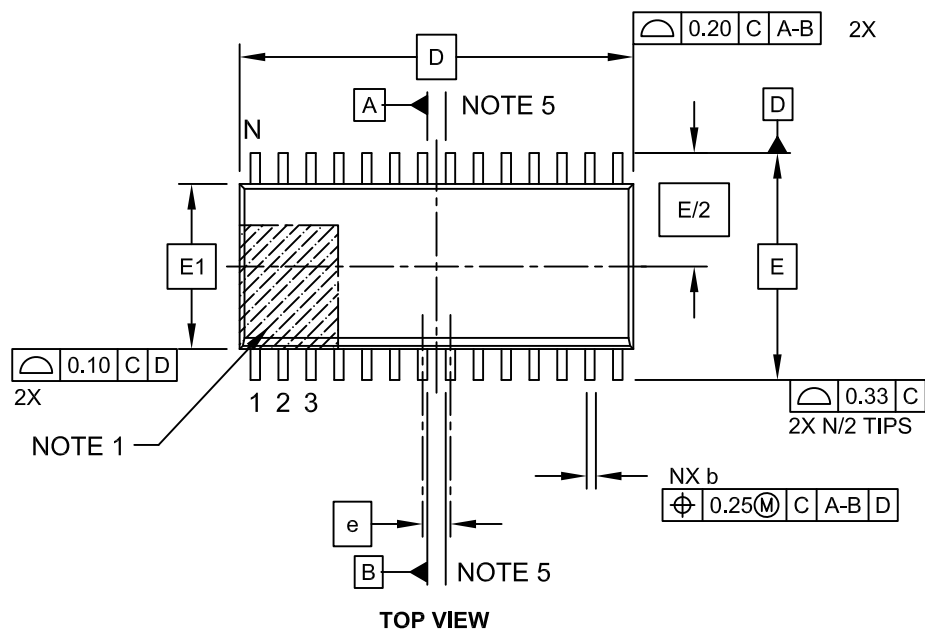
FIGURE 19-19: WAVEFORMS AND INTERRUPT TIMING IN QUARTER-DUTY CYCLE DRIVE (EXAMPLE – TYPE-B, NON-STATIC)



PIC16LF1904/6/7

28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

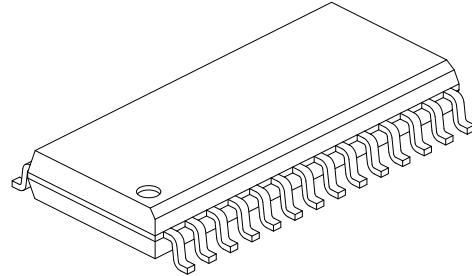
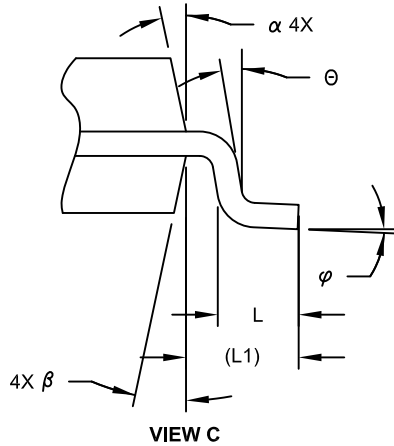
Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



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28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Dimension	Units	MILLIMETERS		
		MIN	NOM	MAX
Number of Pins	N	28		
Pitch	e	1.27 BSC		
Overall Height	A	-	-	2.65
Molded Package Thickness	A2	2.05	-	-
Standoff §	A1	0.10	-	0.30
Overall Width	E	10.30 BSC		
Molded Package Width	E1	7.50 BSC		
Overall Length	D	17.90 BSC		
Chamfer (Optional)	h	0.25	-	0.75
Foot Length	L	0.40	-	1.27
Footprint	L1	1.40 REF		
Lead Angle	θ	0°	-	-
Foot Angle	φ	0°	-	8°
Lead Thickness	c	0.18	-	0.33
Lead Width	b	0.31	-	0.51
Mold Draft Angle Top	α	5°	-	15°
Mold Draft Angle Bottom	β	5°	-	15°

Notes:

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- § Significant Characteristic
- Dimension D does not include mold flash, protrusions or gate burrs, which shall not exceed 0.15 mm per end. Dimension E1 does not include interlead flash or protrusion, which shall not exceed 0.25 mm per side.
- Dimensioning and tolerancing per ASME Y14.5M
 - BSC: Basic Dimension. Theoretically exact value shown without tolerances.
 - REF: Reference Dimension, usually without tolerance, for information purposes only.
- Datums A & B to be determined at Datum H.

Microchip Technology Drawing C04-052C Sheet 2 of 2

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